

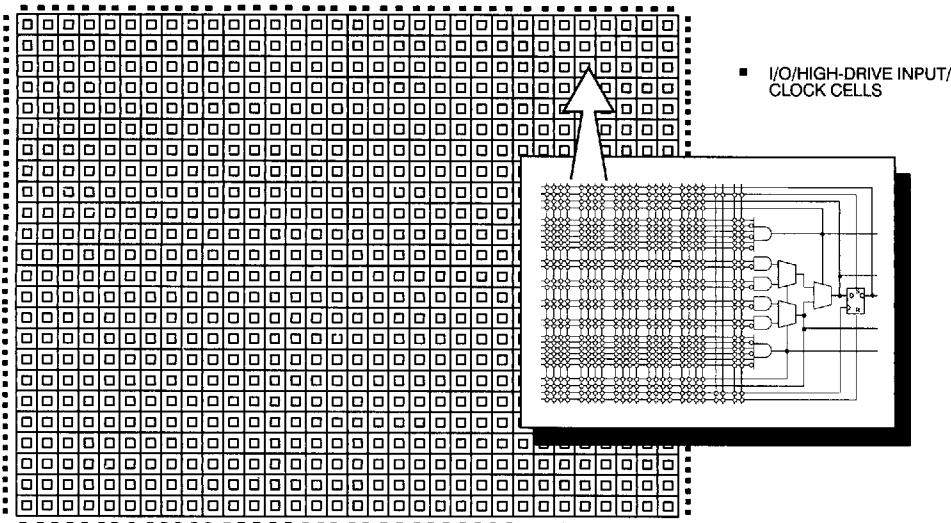
# Very High Speed 8K (24K) Gate CMOS FPGA

## Features

- Very high speed
  - Loadable counter frequencies greater than 100 MHz
  - Chip-to-chip operating frequencies up to 85 MHz
  - Input + logic cell + output delays under 7 ns
- Unparalleled FPGA performance for counters, data path, state machines, arithmetic, and random logic
- High usable density
  - 24 x 32 array of 768 logic cells provides 24,000 total available gates
  - 8,000 typically usable “gate array” gates in 145-pin and 245-pin CPGA, 144-pin TQFP, 208-pin PQFP, 160-pin CQFP, and 225-pin BGA packages
- PCI compliant I/O pins
- Low power, high output drive
  - Standby current typically 2 mA

- 16-bit counter operating at 100 MHz consumes 50 mA
- Minimum  $I_{OL}$  of 12 mA and  $I_{OH}$  of 8 mA
- Flexible logic cell architecture
  - Wide fan-in (up to 14 input gates)
  - Multiple outputs in each cell
  - Very low cell propagation delay (1.7 ns)
- Powerful design tools—*Warp3™*
  - Designs entered in VHDL, schematics, or mixed
  - Fast, fully automatic place and route
  - Waveform simulation with back annotated net delays
  - PC and workstation platforms
- Robust routing resources
  - Fully automatic place and route of designs using up to 100 percent of logic resources
  - No hand routing required
- 132 (7C387A) to 172 (7C388A) bidirectional input/output pins
- 6 dedicated input/high-drive pins
- 2 clock/dedicated input pins with fan-out-independent, low-skew nets
  - Clock skew <1 ns
- Input hysteresis provides high noise immunity
- Thorough testability
  - Built-in scan path permits 100 percent factory testing of logic and I/O cells
  - Automatic Test Vector Generation (ATVG) software supports user testing after programming
- 0.65 $\mu$  CMOS process with ViaLink™ programming technology
  - High-speed metal-to-metal link
  - Non-volatile antifuse technology
- 144-pin TQFP, 145-pin CPGA, and 160-pin CQFP are pin compatible with the CY7C386A

## Logic Block Diagram



7C387A-1

144 and 208 PINS, 172 I/O CELLS, 6 INPUT HIGH DRIVE CELLS, 2 INPUT/CLK (HIGH DRIVE) CELLS

ViaLink and pASIC are trademarks of QuickLogic Corporation.  
*Warp3* is a trademark of Cypress Semiconductor Corporation.

## Functional Description

The CY7C387A and CY7C388A are very high speed, CMOS, user-programmable ASIC (pASIC™) devices. The 768 logic cell field-programmable gate array (FPGA) offers 8,000 typically usable "gate array" gates. This is equivalent to 24,000 EPLD or LCA gates. The CY7C387A is available in a 145-pin CPGA, 160-pin CQFP, and 144-pin TQFP. The CY7C388A is available in 208-pin PQFP, 245-pin CPGA, and 225-pin BGA packages.

Low-impedance, metal-to-metal ViaLink interconnect technology provides non-volatile custom logic capable of operating at speeds above 150 MHz with input and output delays under 3 ns. This per-

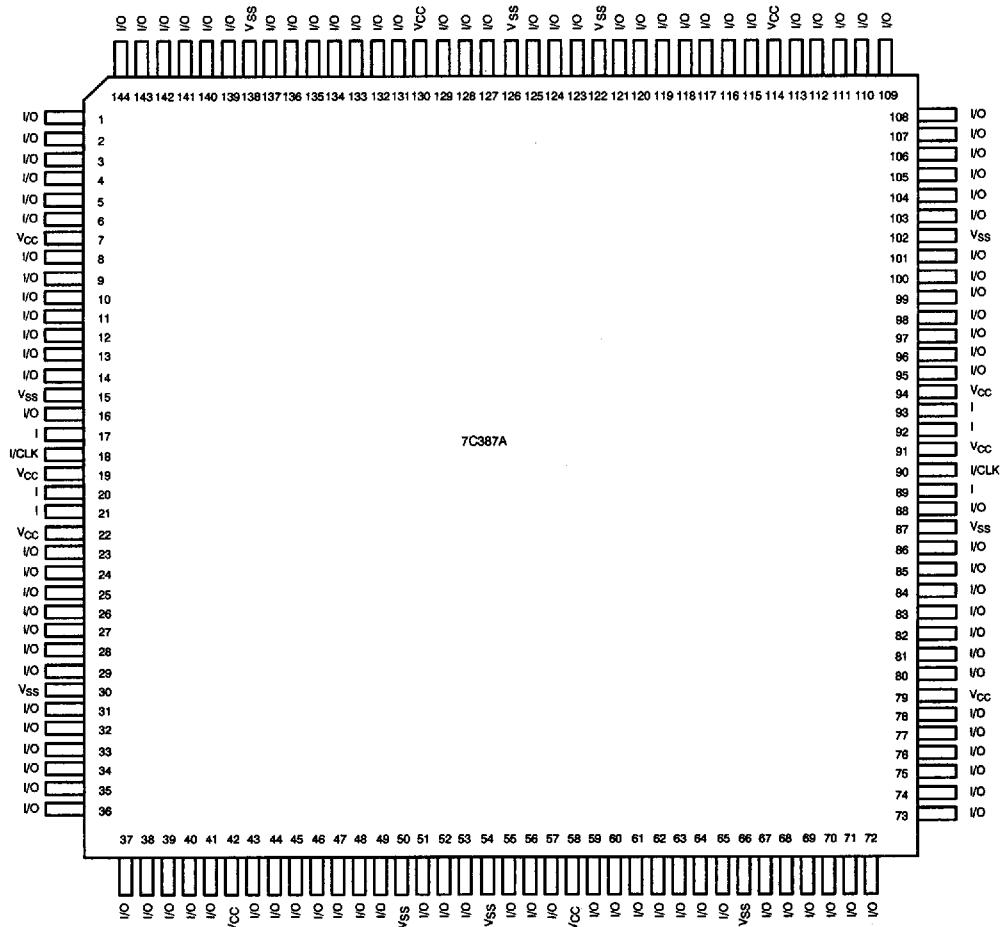
mits high-density programmable devices to be used with today's fastest CISC and RISC microprocessors.

Designs are entered into the CY7C387A and CY7C388A using Cypress *Warp3* software or one of several third-party tools. *Warp3* is a sophisticated CAE package that features schematic entry, waveform-based timing simulation, and VHDL design synthesis. The CY7C387A and CY7C388A feature ample on-chip routing channels for fast, fully automatic place and route of high gate utilization designs.

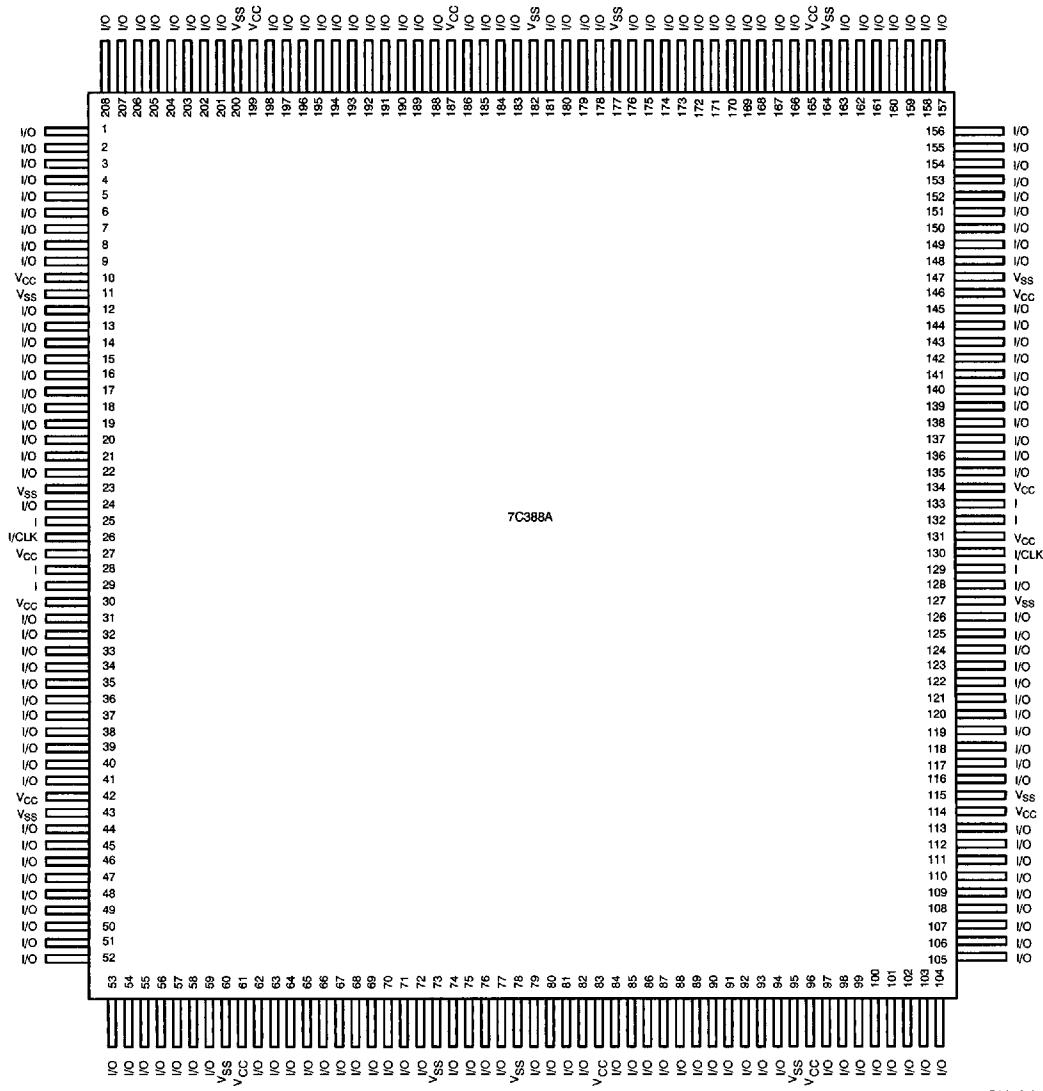
For detailed information about the pASIC380 architecture, see the pASIC380 Family datasheet.

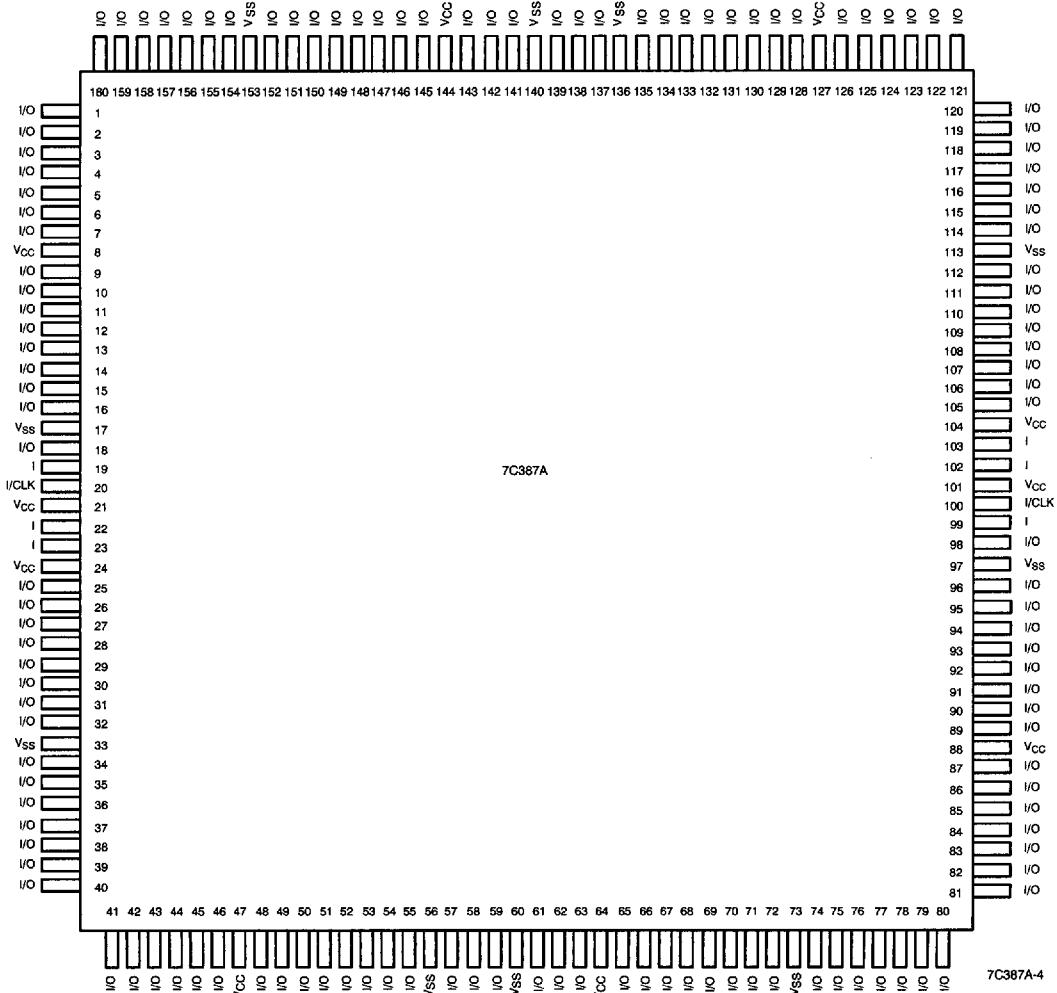
## Pin Configurations

**144-Pin Thin Quad Flat Pack (TQFP)  
Top View**



7C387A-2

**Pin Configurations (continued)**
**208-Pin Plastic Quad Flat Pack (PQFP)  
Top View**


**Pin Configurations (continued)**
**160-Pin CQFP  
Top View**


**Pin Configurations (continued)**
**145-Pin CPGA  
Bottom View**

R	P	N	M	L	K	J	H	G	F	E	D	C	B	A	
I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	1
I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	2
I/O	I/O	V <sub>SS</sub>	I/O	V <sub>CC</sub>	I/O	V <sub>SS</sub>	I/O	V <sub>CC</sub>	I/O	V <sub>SS</sub>	I/O	V <sub>CC</sub>	I/O	I/O	3
I/O	I/O	I/O													4
I/O	I/O	V <sub>CC</sub>										V <sub>SS</sub>	I/O	I/O	5
I/O	I/O	I/O											I/O	I/O	6
I	I	V <sub>SS</sub>										V <sub>CC</sub>	I/O	I/O	7
I/O	I	I/CLK										I/CLK	I	I/O	8
I/O	I/O	V <sub>CC</sub>										V <sub>SS</sub>	I	I	9
I/O	I/O	I/O											I/O	I/O	10
I/O	I/O	V <sub>SS</sub>										V <sub>CC</sub>	I/O	I/O	11
I/O	I/O	I/O											I/O	I/O	12
I/O	I/O	V <sub>CC</sub>	I/O	V <sub>SS</sub>	I/O	V <sub>CC</sub>	I/O	V <sub>SS</sub>	I/O	V <sub>CC</sub>	I/O	V <sub>SS</sub>	I/O	I/O	13
I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	14
I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	15

7C387A

4

7C387A-5



CYPRESS

## PRELIMINARY

CY7C387A

CY7C388A

**Maximum Ratings**

(Above which the useful life may be impaired. For user guidelines, not tested.)

## Storage Temperature

Ceramic .....	-65°C to +150°C
Plastic .....	-40°C to +125°C

Lead Temperature ..... 300°C

Supply Voltage ..... -0.5V to +7.0V

Input Voltage ..... -0.5V to V<sub>CC</sub> +0.5V

ESD Pad Protection ..... ±2000 V

DC Input Voltage ..... -0.5V to 7.0V

Latch-Up Current ..... ±200 mA

**Operating Range**

Range	Ambient Temperature	V <sub>CC</sub>
Commercial	0°C to +70°C	5V ± 5%
Industrial	-40°C to +85°C	5V ± 10%
Military	-55°C to +125°C	5V ± 10%

**Delay Factor (K)**

Speed Grade	Military		Industrial		Commercial	
	Min.	Max.	Min.	Max.	Min.	Max.
-0	0.39	1.82	0.4	1.67	0.46	1.55
-1	0.39	1.56	0.4	1.43	0.46	1.33
-2			0.4	1.35	0.46	1.25

**Electrical Characteristics Over the Operating Range**

Parameter	Description	Test Conditions	Min.	Max.	Unit
V <sub>OH</sub>	Output HIGH Voltage	I <sub>OH</sub> = -4.0 mA	3.7		V
		I <sub>OH</sub> = -8.0 mA	2.4		V
		I <sub>OH</sub> = -10.0 μA	V <sub>CC</sub> - 0.1		V
V <sub>OL</sub>	Output LOW Voltage	I <sub>OL</sub> = 8.0 mA Military/Industrial I <sub>OL</sub> = 12 mA Commercial		0.4	V
		I <sub>OL</sub> = 10.0 μA		0.1	V
			2.0		V
V <sub>IH</sub>	Input HIGH Voltage			0.8	V
V <sub>IL</sub>	Input LOW Voltage				
I <sub>l</sub>	Input Leakage Current	V <sub>IN</sub> = V <sub>CC</sub> or V <sub>SS</sub>	-10	+10	μA
I <sub>OZ</sub>	Three-State Output Leakage Current	V <sub>IN</sub> = V <sub>CC</sub> or V <sub>SS</sub>	-10	+10	μA
I <sub>OS</sub>	Output Short Circuit Current	V <sub>OUT</sub> = V <sub>SS</sub>	-10	-80	mA
		V <sub>OUT</sub> = V <sub>CC</sub>	30	140	mA
I <sub>CC</sub>	Standby Supply Current	V <sub>IN</sub> , V <sub>IO</sub> = V <sub>CC</sub> or V <sub>SS</sub>		10	mA

**Capacitance**

Parameter	Description	Test Conditions	Max.	Unit
C <sub>IN</sub>	Input Capacitance	T <sub>A</sub> = 25°C, f = 1 MHz, V <sub>CC</sub> = 5.0V	10	pF
C <sub>OUT</sub>	Output Capacitance		10	pF



CYPRESS

PRELIMINARY

CY7C387A  
CY7C388A

## Switching Characteristics Over the Operating Range

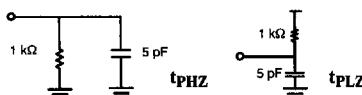
Parameter	Description	Propagation Delays <sup>[1]</sup> with Fanout of						Unit
		1	2	3	4	8		
<b>LOGIC CELLS</b>								
t <sub>PD</sub>	Combinatorial Delay <sup>[2]</sup>	1.7	2.2	2.6	3.2	5.3	ns	
t <sub>SU</sub>	Set-Up Time <sup>[2]</sup>	2.1	2.1	2.1	2.1	2.1	ns	
t <sub>H</sub>	Hold Time	0.0	0.0	0.0	0.0	0.0	ns	
t <sub>CLK</sub>	Clock to Q Delay	1.0	1.5	1.9	2.6	4.7	ns	
t <sub>CWHI</sub>	Clock HIGH Time	2.0	2.0	2.0	2.0	2.0	ns	
t <sub>CWLO</sub>	Clock LOW Time	2.0	2.0	2.0	2.0	2.0	ns	
t <sub>SET</sub>	Set Delay	1.7	2.2	2.6	3.2	5.3	ns	
t <sub>RESET</sub>	Reset Delay	1.5	1.9	2.2	2.7	4.4	ns	
t <sub>SW</sub>	Set Width	1.9	1.9	1.9	1.9	1.9	ns	
t <sub>RW</sub>	Reset Width	1.8	1.8	1.8	1.8	1.8	ns	

Parameter	Description	Propagation Delays <sup>[1]</sup> with Fanout of						Unit
		1	2	3	4	8	12	
<b>INPUT CELLS</b>								
t <sub>IN</sub>	Input Delay (HIGH Drive)	2.8	2.9	3.0	3.1	4.0	5.3	ns
t <sub>INI</sub>	Input, Inverting Delay (HIGH Drive)	3.0	3.1	3.2	3.3	4.1	5.7	ns
t <sub>IO</sub>	Input Delay (Bidirectional Pad)	1.4	1.9	2.2	2.2	4.7	6.5	ns
t <sub>GCK</sub>	Clock Buffer Delay <sup>[3]</sup>	2.7	2.8	2.9	3.0	3.1	3.3	ns
t <sub>GCKHI</sub>	Clock Buffer Min. HIGH <sup>[3]</sup>	2.0	2.0	2.0	2.0	2.0	2.0	ns
t <sub>GCKLO</sub>	Clock Buffer Min. LOW <sup>[3]</sup>	2.0	2.0	2.0	2.0	2.0	2.0	ns

Parameter	Description	Propagation Delays <sup>[1]</sup> with Output Load Capacitance (pF) of					Unit
		30	50	75	100	150	
<b>OUTPUT CELLS</b>							
t <sub>OUTLH</sub>	Output Delay LOW to HIGH	2.7	3.4	4.2	5.0	6.7	ns
t <sub>OUTHL</sub>	Output Delay HIGH to LOW	2.8	3.7	4.7	5.6	7.6	ns
t <sub>PZH</sub>	Output Delay Three-State to HIGH	4.0	4.9	6.1	7.3	9.7	ns
t <sub>PZL</sub>	Output Delay Three-State to LOW	3.6	4.2	5.0	5.8	7.3	ns
t <sub>PHZ</sub>	Output Delay HIGH to Three-State <sup>[4]</sup>	2.9					ns
t <sub>PLZ</sub>	Output Delay LOW to Three-State <sup>[4]</sup>	3.3					ns

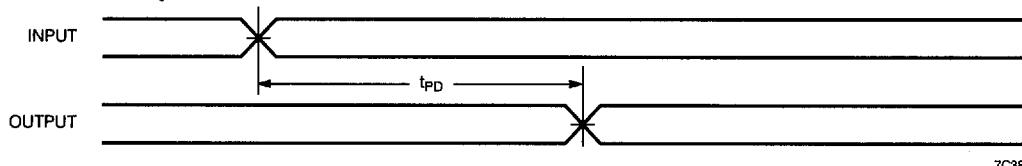
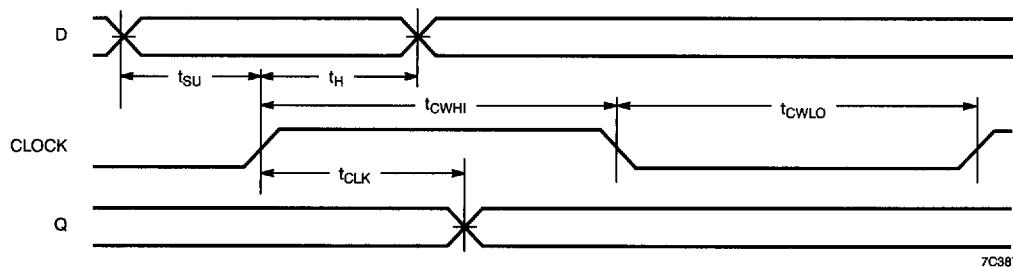
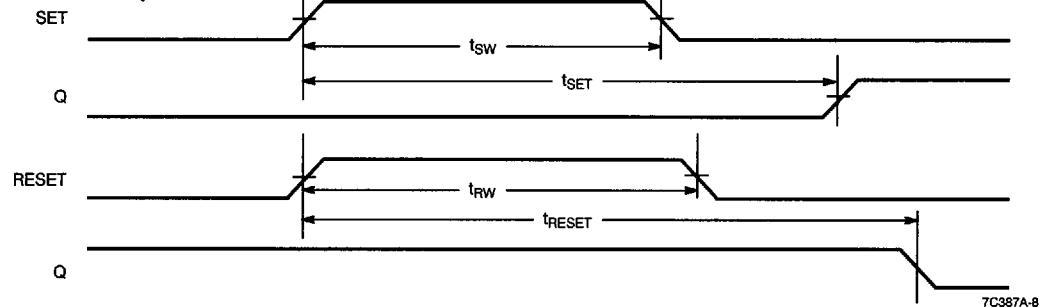
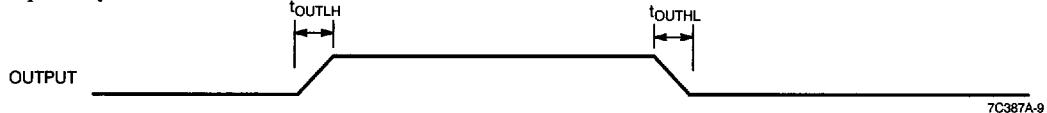
## Notes:

- Worst-case propagation delay times over process variation at V<sub>CC</sub> = 5.0V and T<sub>A</sub> = 25°C. Multiply by the appropriate delay factor, K, for speed grade to get worst-case parameters over full V<sub>CC</sub> and temperature range as specified in the operating range. All inputs are TTL with 3-ns linear transition time between 0 and 3 volts.
- These limits are derived from worst-case values for a representative selection of the slowest paths through the pASIC logic cell including net delays. Guaranteed delay values for specific paths should be determined from simulation results.
- Clock buffer fanout refers to the maximum number of flip-flops per half column. The number of half columns used does not affect clock buffer delay.
- The following loads are used for t<sub>pxz</sub>:



**High Drive Buffer**

Parameter	Description	# High Drives Wired Together	Propagation Delays <sup>[1]</sup> with Fanout of					Unit
			12	24	48	72	96	
$t_{IN}$	High Drive Input Delay	1	5.3	6.7				ns
		2		4.5	6.6			ns
		3			5.3	6.2	7.2	ns
		4				5.4	6.2	ns
$t_{INI}$	High Drive Input, Inverting Delay	1	5.7	7.2				ns
		2		4.6	6.8			ns
		3			5.5	6.4	7.4	ns
		4				5.6	6.4	ns

**Switching Waveforms**
**Combinatorial Delay**

**Set-Up and Hold Times**

**Set and Reset Delays**

**Output Delay**




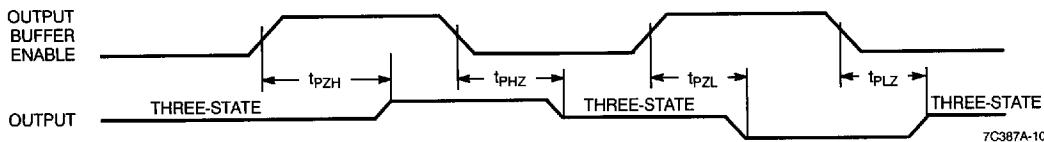
CYPRESS

PRELIMINARY

CY7C387A  
CY7C388A

## Switching Waveforms (continued)

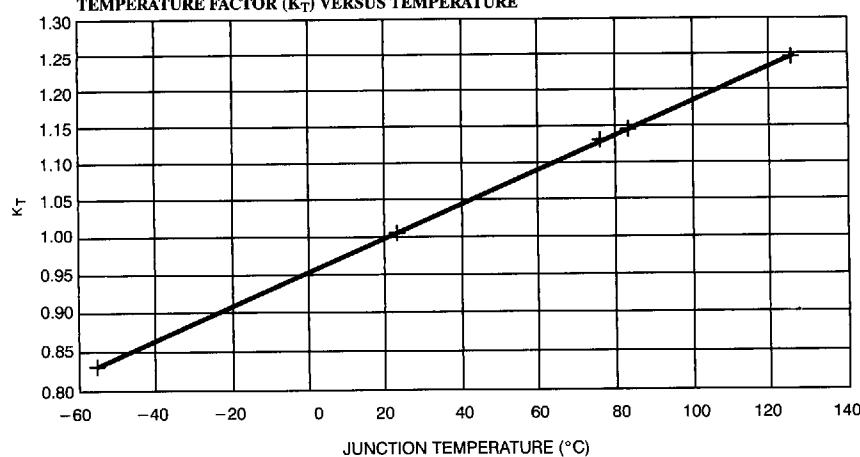
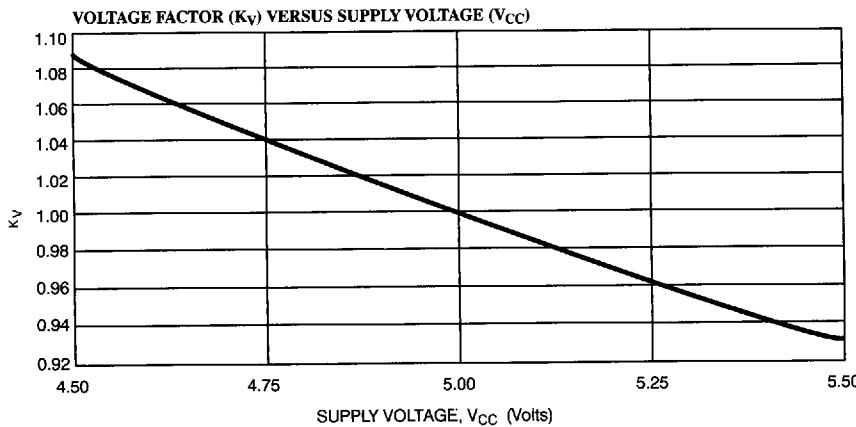
## Three-State Delay



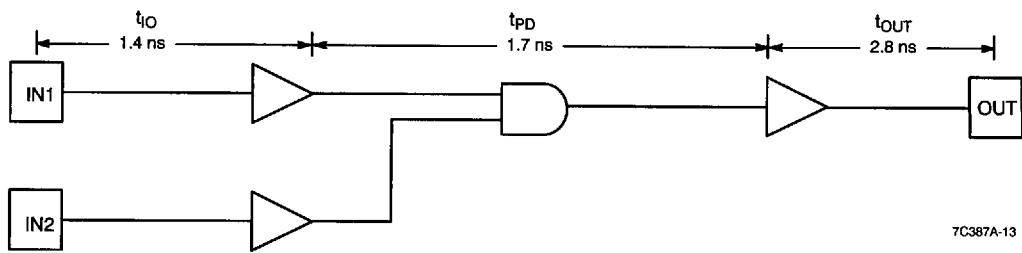
## Typical AC Characteristics

Propagation delays depend on routing, fanout, load capacitance, supply voltage, junction temperature, and process variation. The AC Characteristics are a design guide to provide initial timing estimates at nominal conditions. Worst-case estimates are obtained when nominal propagation delays are multiplied by the appropriate Delay Factor, K, as specified by the speed grade in the Delay

Factor table. The effects of voltage and temperature variation are illustrated in the graphs below. *Warp3* incorporates datasheet AC Characteristics into the design database for pre-place-and-route simulations. The *Warp3* Delay Modeler extracts specific timing parameters for precise simulation results following place and route.

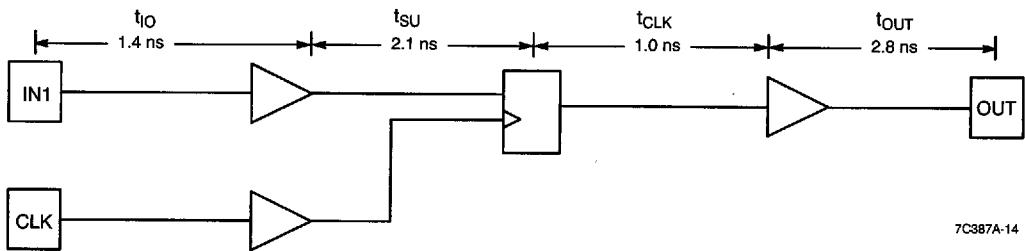


\*THETA JA = 45 °C/WATT FOR PLCC

**Combinatorial Delay Example (Load = 30 pF)**


7C387A-13

$$\text{INPUT DELAY} + \text{COMBINATORIAL DELAY} + \text{OUTPUT DELAY} = 5.9 \text{ ns}$$

**Sequential Delay Example (Load = 30 pF)**


7C387A-14

$$\text{INPUT DELAY} + \text{REG SET-UP} + \text{CLOCK TO OUTPUT} + \text{OUTPUT DELAY} = 7.3 \text{ ns}$$

**Ordering Information**

Speed Grade	Ordering Code	Package Name	Package Type	Operating Range
2	CY7C387A-2AC	A144	144-Pin Thin Quad Flat Pack	Commercial
	CY7C387A-2GC	G145	145-Pin Grid Array (Cavity Up)	
	CY7C387A-2AI	A144	144-Pin Thin Quad Flat Pack	Industrial
	CY7C387A-2GI	G145	145-Pin Grid Array (Cavity Up)	
1	CY7C387A-1AC	A144	144-Pin Thin Quad Flat Pack	Commercial
	CY7C387A-1GC	G145	145-Pin Grid Array (Cavity Up)	
	CY7C387A-1AI	A144	144-Pin Thin Quad Flat Pack	Industrial
	CY7C387A-1GI	G145	145-Pin Grid Array (Cavity Up)	
	CY7C387A-1GMB	G145	145-Pin Grid Array (Cavity Up)	Military
	CY7C387A-1UMB	U162	160-Lead Ceramic Quad Flatpack (Cavity Up)	
0	CY7C387A-0AC	A144	144-Pin Thin Quad Flat Pack	Commercial
	CY7C387A-0GC	G145	145-Pin Grid Array (Cavity Up)	
	CY7C387A-0AI	A144	144-Pin Thin Quad Flat Pack	Industrial
	CY7C387A-0GI	G145	145-Pin Grid Array (Cavity Up)	
	CY7C387A-0GMB	G145	145-Pin Grid Array (Cavity Up)	Military
	CY7C387A-0UMB	U162	160-Lead Ceramic Quad Flatpack (Cavity Up)	

Speed Grade	Ordering Code	Package Name	Package Type	Operating Range
2	CY7C388A-2AC	A208	208-Pin Thin Quad Flat Pack	Commercial
	CY7C388A-2BGC	B225	225-Pin Ball Grid Array	
	CY7C388A-2GC	G245	245-Pin Grid Array (Cavity Up)	
	CY7C388A-2AI	A208	208-Pin Thin Quad Flat Pack	Industrial
	CY7C388A-2GI	G245	245-Pin Grid Array (Cavity Up)	
1	CY7C388A-1AC	A208	208-Pin Thin Quad Flat Pack	Commercial
	CY7C388A-1BGC	B225	225-Pin Ball Grid Array	
	CY7C388A-1GC	G245	245-Pin Grid Array (Cavity Up)	
	CY7C388A-1AI	A208	208-Pin Thin Quad Flat Pack	Industrial
	CY7C388A-1GI	G245	245-Pin Grid Array (Cavity Up)	
	CY7C388A-1GMB	G245	245-Pin Grid Array (Cavity Up)	Military
0	CY7C388A-0AC	A208	208-Pin Thin Quad Flat Pack	Commercial
	CY7C388A-0BGC	B225	225-Pin Ball Grid Array	
	CY7C388A-0GC	G245	245-Pin Grid Array (Cavity Up)	
	CY7C388A-0AI	A208	208-Pin Thin Quad Flat Pack	Industrial
	CY7C388A-0GI	G245	245-Pin Grid Array (Cavity Up)	
	CY7C388A-0GMB	G245	245-Pin Grid Array (Cavity Up)	Military

Shaded area contains advanced information.

**Military Specifications  
Group A Subgroup Testing**
**DC Characteristics**

Parameters	Subgroups
V <sub>OH</sub>	1, 2, 3
V <sub>OL</sub>	1, 2, 3
I <sub>OZ</sub>	1, 2, 3
I <sub>CC1</sub>	1, 2, 3

Document #: 38-00373



CYPRESS

ADVANCED INFORMATION

CY7C389A

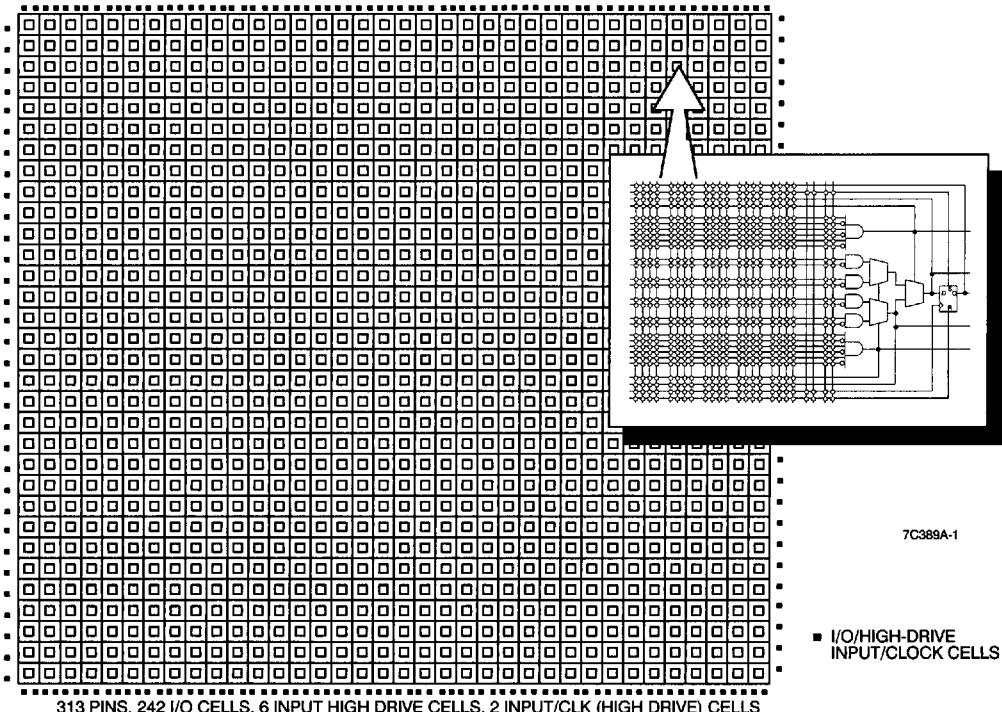
## Very High Speed 12K (36K) Gate CMOS FPGA

### Features

- Very high speed
  - Loadable counter frequencies greater than 100 MHz
  - Chip-to-chip operating frequencies up to 85 MHz
  - Input + logic cell + output delays under 7 ns
- Unparalleled FPGA performance for counters, data path, state machines, arithmetic, and random logic
- High usable density
  - 32 x 36 array of 1152 logic cells provides 36,000 total available gates
  - 12,000 typically usable "gate array" gates in 208-pin PQFP, 313-pin BGA, and 245-pin CQFP packages

- Low power, high output drive
  - Standby current typically 2 mA
  - 16-bit counter operating at 100 MHz consumes 50 mA
  - Minimum  $I_{OL}$  and  $I_{OH}$  of 8 mA
- Flexible logic cell architecture
  - Wide fan-in (up to 14 input gates)
  - Multiple outputs in each cell
  - Very low cell propagation delay (1.7 ns)
- PCI compliant I/O pins
- Powerful design tools—*Warp3™*
  - Designs entered in VHDL, schematics, or both
  - Fast, fully automatic place and route
  - Waveform simulation with back annotated net delays
- Input hysteresis provides high noise immunity
- Thorough testability
  - Built-in scan path permits 100 percent factory testing of logic and I/O cells
  - Automatic Test Vector Generation (ATVG) software supports user testing after programming
- 0.65 $\mu$  CMOS process with ViaLink™ programming technology
  - High-speed metal-to-metal link
  - Non-volatile antifuse technology

### Logic Block Diagram



ViaLink is a trademark of QuickLogic Corporation.

*Warp3* is a trademark of Cypress Semiconductor Corporation.